RoHS

COMPLIANT HALOGEN FREE



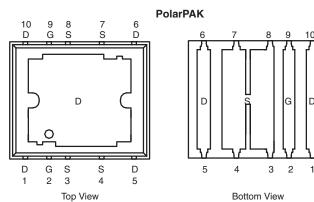
Vishay Siliconix

# N-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY							
		I <sub>D</sub> (A) <sup>a</sup>					
V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (</b> Ω)	Silicon Limit	Package Limit	Q <sub>g</sub> (Typ.)			
20	0.0035 at $V_{GS}$ = 4.5 V	136	50	43 nC			
20	0.0064 at $V_{GS}$ = 2.5 V	100	50	43110			

Package Drawing

www.vishay.com/doc?73398



Top surface is connected to pins 1, 5, 6, and 10 Ordering Information: SiE820DF-T1-E3 (Lead (Pb)-free)

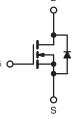
SiE820DF-T1-GE3 (Lead (Pb)-free and Halogen-free)

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- Extremely Low  $\ensuremath{\mathsf{Q}_{gd}}$  WFET Technology for Low Switching Losses
- TrenchFET<sup>®</sup> Power MOSFET
- Ultra Low Thermal Resistance Using Top-Exposed PolarPAK<sup>®</sup> Package for Double-Sided Cooling
- Leadframe-Based New Encapsulated Package - Die Not Exposed
- Same Layout Regardless of Die Size
- Low  $Q_{gd}/Q_{gs}$  Ratio Helps Prevent Shoot-Through 100 %  $R_g$  and UIS Tested
- Compliant to RoHS directive 2002/95/EC

#### APPLICATIONS

- VRM
- **DC/DC** Conversion
- Synchronous Rectification



D

N-Channel MOSFET

For Related Documents www.vishay.com/ppg?74447

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	20	V	
Gate-Source Voltage		V <sub>GS</sub>	± 12	V	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C T <sub>C</sub> = 70 °C		136 (Silicon Limit) 50 <sup>a</sup> (Package Limit) 50 <sup>a</sup>		
Pulsed Drain Quart	T <sub>A</sub> = 25 °C T <sub>A</sub> = 70 °C		30 <sup>b, c</sup> 24 <sup>b, c</sup>	A	
Pulsed Drain Current		I <sub>DM</sub>	80		
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C T <sub>A</sub> = 25 °C	I <sub>S</sub>	<u> </u>		
Single Pulse Avalanche Current L = 0.1 mH		I <sub>AS</sub>	30		
Avalanche Energy		E <sub>AS</sub>	45		
Maximum Power Dissipation $ \begin{array}{c} T_{C} = 25 \ ^{\circ}C \\ \hline T_{C} = 70 \ ^{\circ}C \\ \hline T_{A} = 25 \ ^{\circ}C \\ \hline T_{A} = 70 \ ^{\circ}C \end{array} $		P <sub>D</sub>	104 66 5.2 <sup>b, c</sup> 3.3 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	<u></u>	
Soldering Recommendations (Peak Temperature) <sup>d, e</sup>			260		

Notes:

a. Package limited is 50 A.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. See Solder Profile (www.vishay.com/doc?73257). The PolarPAK is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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### THERMAL RESISTANCE RATINGS

Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>a, b</sup>	t ≤ 10 s	R <sub>thJA</sub>	20	24			
Maximum Junction-to-Case (Drain Top) <sup>a</sup>	Steady State	R <sub>thJC</sub> (Drain)	1	1.2	°C/W		
Maximum Junction-to-Case (Source) <sup>a, c</sup>	Sleady State	R <sub>thJC</sub> (Source)	2.8	3.4			

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

b. Maximum under Steady State conditions is 68 °C/W.

c. Measured at source pin (on the side of the package).

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static			•				
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_{D} = 250 \mu A$	20			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$	I <sub>D</sub> = 250 μA		20			
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 4.8		mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	0.6	1.4	2	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 100	nA	
Zero Gate Voltage Drain Current		$V_{DS} = 20 V, V_{GS} = 0 V$			1	μΑ	
	IDSS	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	25			А	
Drain Course On State Desistance	D	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 18 A		0.0029	0.0035	Ω	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 2.5 V, I <sub>D</sub> = 13.4 A		0.0053	0.0064		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 18 A		106		S	
Dynamic <sup>b</sup>			•				
Input Capacitance	C <sub>iss</sub>			4300		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$		950			
Reverse Transfer Capacitance	C <sub>rss</sub>			450			
Total Gate Charge	Qg	$V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 20 \text{ A}$		95	143	nC	
				43	65		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = 10 V, $V_{GS}$ = 4.5 V, $I_{D}$ = 20 A		11.5			
Gate-Drain Charge	Q <sub>gd</sub>			10			
Gate Resistance	Rg	f = 1 MHz		1.0	1.5	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			35	55		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 10 V, $R_L$ = 1.0 $\Omega$		115	175		
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_\text{D} \cong$ 10 A, $\text{V}_\text{GEN}$ = 4.5 V, $\text{R}_\text{g}$ = 1 $\Omega$		105	160		
Fall Time	t <sub>f</sub>			30	45		
Turn-On Delay Time	t <sub>d(on)</sub>			15	25	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 10 V, $R_L$ = 1.0 $\Omega$		35	55		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ 10 A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$		55	85		
Fall Time	t <sub>f</sub>			10	15		
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			50	A	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				80	~	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 10 A		0.8	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			101	150	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = 10 A, dl/dt = 100 A/μs, T <sub>.I</sub> = 25 °C		100	150	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$F = 10 \text{ A}, \text{ div}\text{di} = 100 \text{ A}/\mu\text{s}, 1 \text{ J} = 25 \text{ C}$		75		ns	
Reverse Recovery Rise Time	t <sub>b</sub>			25			

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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T<sub>C</sub> = - 55 °C

2.6

15

V<sub>GS</sub> = 2.5 V

75

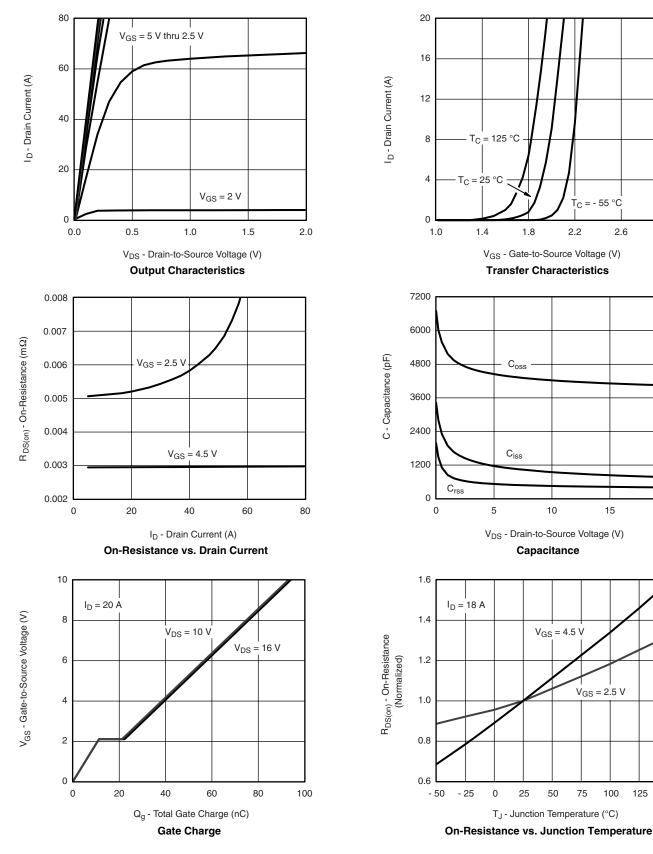
100

3.0

20

2.2

### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



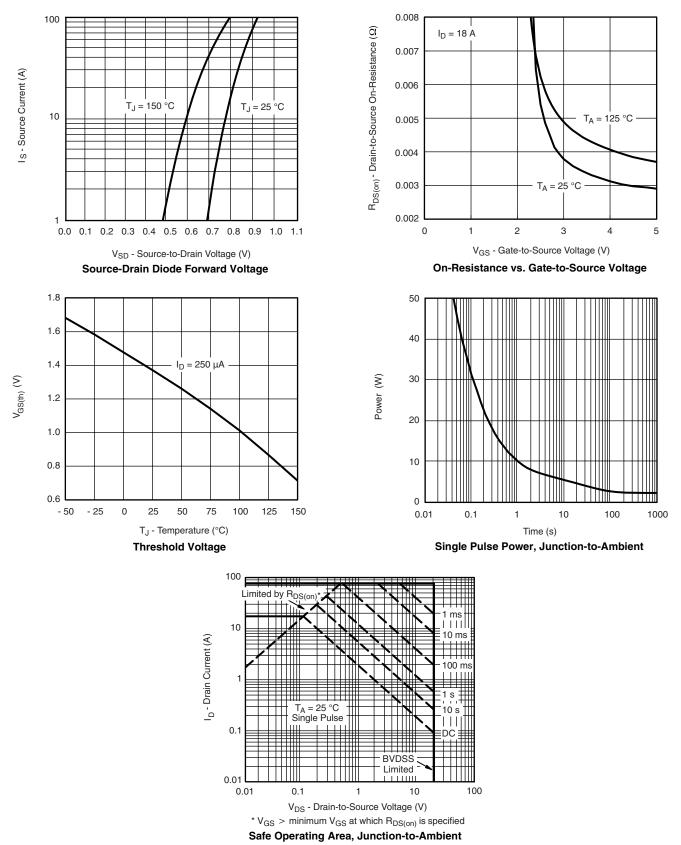
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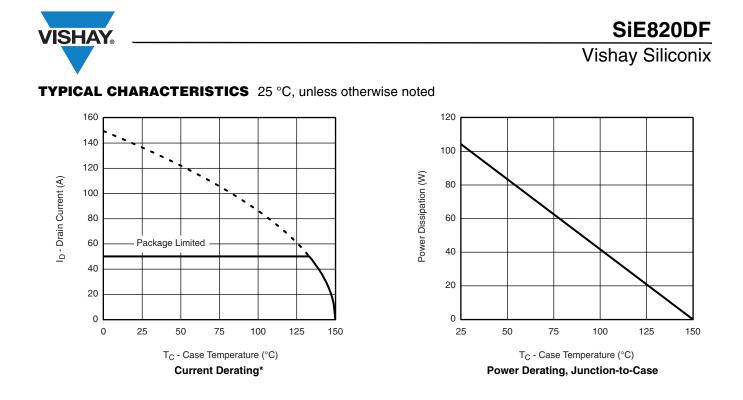
150



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### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



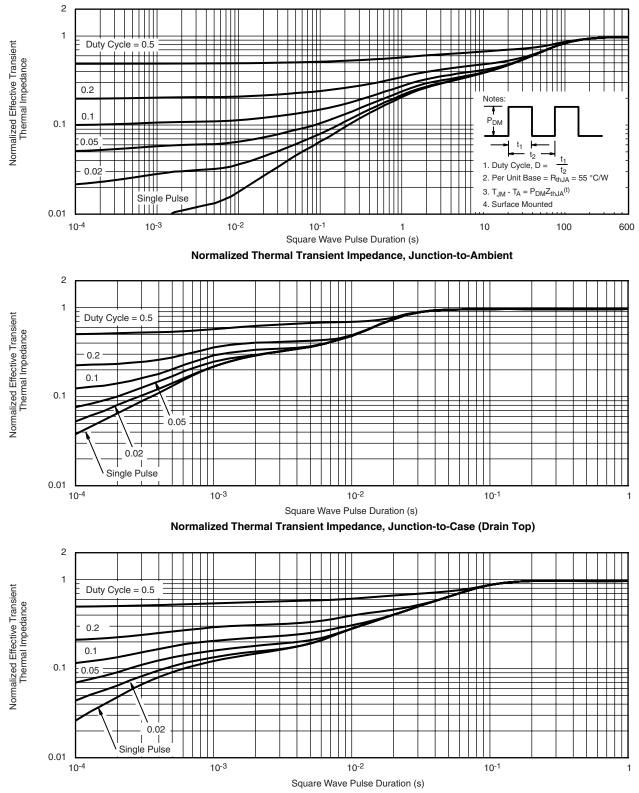


\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Source

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?74447">www.vishay.com/ppg?74447</a>.



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